

**826467-8**

✓ ACTIVE

**AMPMODU | AMPMODU Headers**

TE Internal #: 826467-8

PCB Mount Header, Vertical, Board-to-Board, 8 Position, 2.54 mm [.

1 in] Centerline, Partially Shrouded, AMPMODU Headers

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Connectors &gt; PCB Connectors &gt; PCB Headers &amp; Receptacles

PCB Connector Assembly Type: **PCB Mount Header**PCB Mount Orientation: **Vertical**Connector System: **Board-to-Board**Number of Positions: **8**Number of Rows: **1****Features****Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board

**Configuration Features**

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	8
Number of Rows	1
Board-to-Board Configuration	Parallel

**Electrical Characteristics**

Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 Vrms

**Body Features**

Connector Profile	Standard
Primary Product Color	Black

**Contact Features**

PCB Contact Termination Area Plating Material Thickness	3 μm
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Mating Pin Diameter	.63 mm[.025 in]
Contact Shape & Form	Round
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Zinc, Phosphor Bronze
Contact Mating Area Plating Material	Gold Flash over Palladium Nickel
Contact Mating Area Plating Material Thickness	.8 $\mu$ m[31.5 $\mu$ in]
Contact Type	Pin
Contact Current Rating (Max)	3 A

#### Termination Features

Round Termination Post & Tail Diameter	.63 mm[.025 in]
Termination Post & Tail Length	3.2 mm[.126 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

#### Mechanical Attachment

Mating Retention	With
Mating Retention Type	Detent Latching
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

#### Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester-GF

#### Dimensions

Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]

#### Usage Conditions

Housing Temperature Rating	High
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

#### Operation/Application

Solder Process Feature	Board Standoff
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## Circuit Application

## Signal

## Industry Standards

Agency/Standard

CSA

Approved Standards

CSA LR7189, CUL E28476

UL Flammability Rating

UL 94V-0

## Packaging Features

Packaging Quantity

150

Packaging Type

Carton

## Product Compliance

For compliance documentation, visit the product page on [TE.com](http://TE.com)>

EU RoHS Directive 2011/65/EU

Compliant

EU ELV Directive 2000/53/EC

Compliant

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2023  
(235)Candidate List Declared Against: JUNE  
2023 (235)

Does not contain REACH SVHC

Halogen Content

Not Low Halogen - contains Br or Cl > 900  
ppm.

Solder Process Capability

Pin-in-Paste capable to 260°C

## Product Compliance Disclaimer

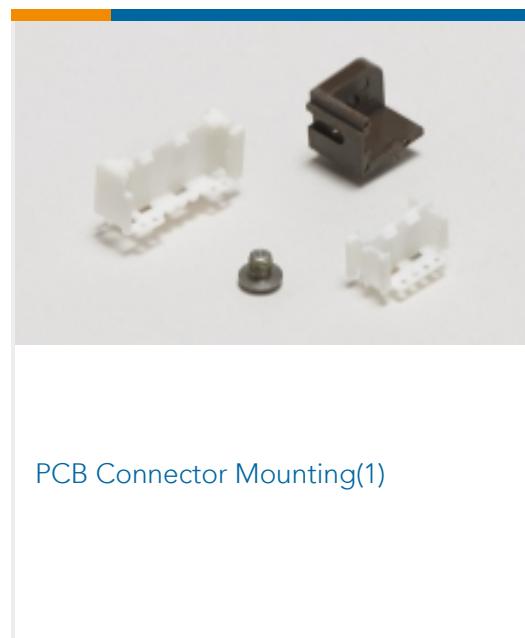
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts

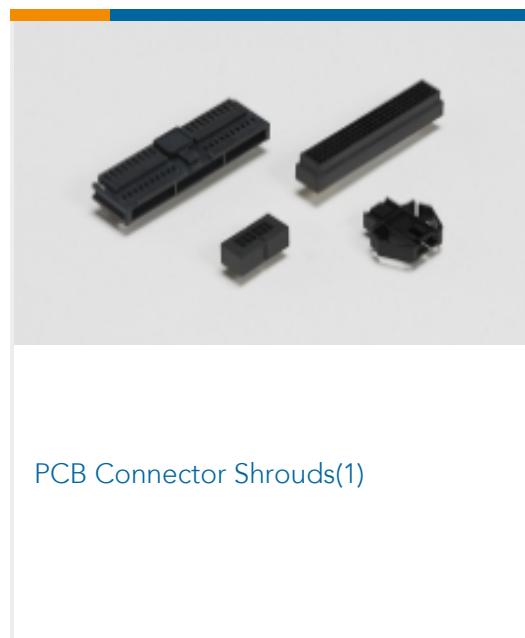


TE Part # 926475-8  
MOD 4 HSG

## Also in the Series | AMPMODU Headers



PCB Connector Mounting(1)



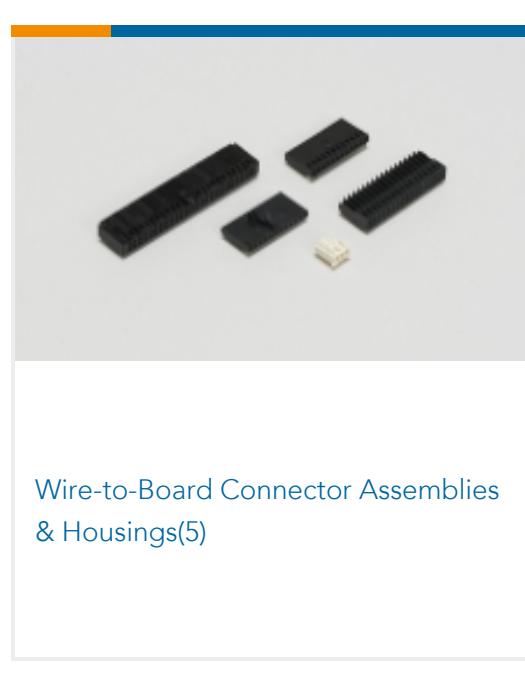
PCB Connector Shrouds(1)



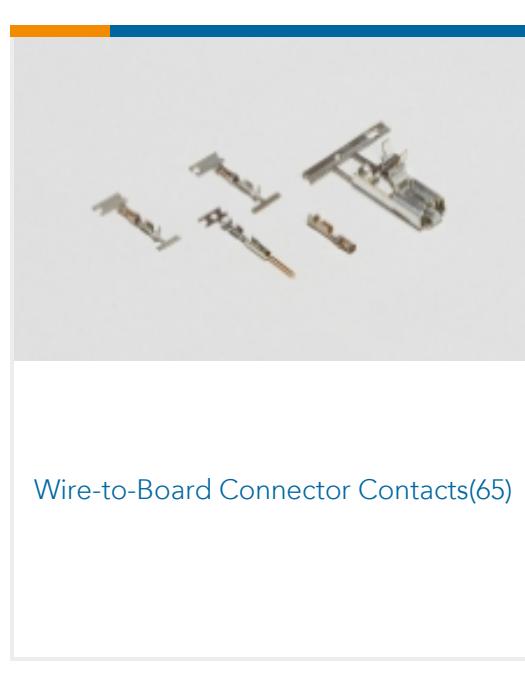
PCB Headers & Receptacles(4875)



PCB Latches, Locks & Retainers(1)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Connector Contacts(65)

## Customers Also Bought



TE Part #5747842-4  
25 MSFL PLUG RA 318 (IN,FM,BL)



TE Part #9-966140-1  
AMP MCP Unsealed Headers



TE Part #1393774-8  
V23026A1002B201



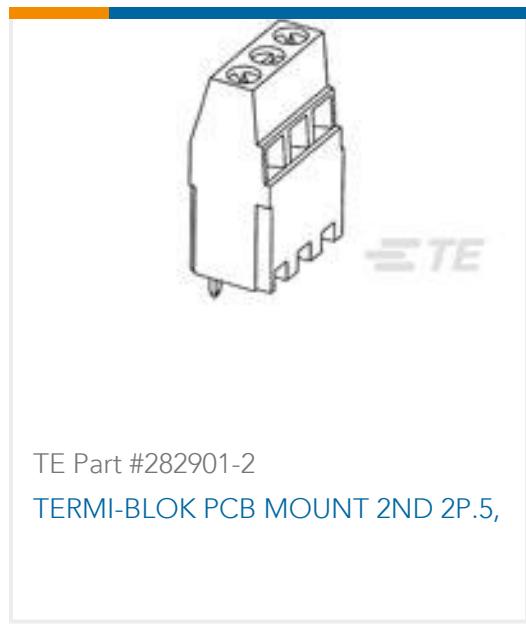
TE Part #1-826632-0  
10P AMPMODU II PIN HDR.



TE Part #4-794630-8  
18P MICRO MNL ASSY,VRT,HDR,LF



TE Part #966870-1  
MOD2 ST-WANNE 2X 8P



TE Part #282901-2  
TERMI-BLOK PCB MOUNT 2ND 2P,5,



TE Part #2-963964-3  
MOS STIFTE MAGAZ



## Documents

### Product Drawings

#### 8P MOD II SHROUDED HEADER, ST

English

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### CAD Files

#### 3D PDF

3D

Customer View Model

[ENG\\_CVM\\_CVM\\_826467-8\\_F.2d\\_dxf.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_826467-8\\_F.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_826467-8\\_F.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

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### Product Environmental Compliance

#### Product Compliance

English

#### Product Compliance

English

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### Agency Approvals

#### UL Report

English